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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application



3C3
3C 895

APPL NUM 10007754	FILING DATE 11/15/2001	CLASS 257 280	SUBCLASS 197	GAU 2876 2812	EXAMINER F. MANDALA
**APPLICANTS: Hill Darrell; Sadaka Mariam; Abrokwhah Jonathan;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A DIV OF 09/641,002 08/17/2000 <i>LATTIN 438</i> <i>2812</i>					
**FOREIGN APPLICATIONS VERIFIED:					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
Verified and Acknowledged Examiners's initials		SC10776P D01			
TITLE : Method of manufacturing a semiconductor component and semiconductor component thereof					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
ISSUE FEE		Sheets Drwg.	Figs. Drwg.
Amount Due	Date Paid	Print Fig.	
		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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